



RE899

- Multiadapter SO8, SO8w, HSOP8, HTSOP8, SOP8
- Epoxy fibre-glass 1.50 mm
- Double-sided 35 µm Cu
- Plated through holes (PTH)
- Surface chem. Ni/Au
- Solder stop mask
- Adaption circuit board for SO8, SO8w, HSOP8, HTSOP8, SOP8
- Pitch 1.27 mm
- Hole spacing 2.54 mm
- Solder pads Ø 2.20 mm, Pin 1 squarely
- Fits on sockets with a distance of 7.62 mm
- Shield pad & cooling pad
- Size 16.51 x 21.59 mm